HD14008B

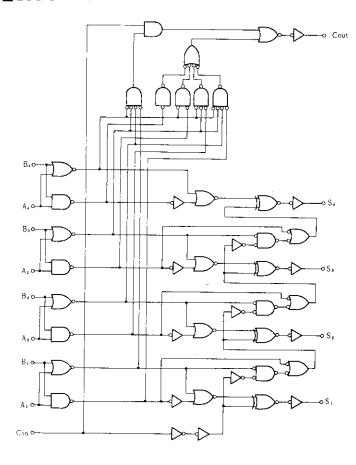
4-bit Full Adder

The HD14008B 4-bit full adder consists of four full adders with fast internal look-ahead carry output. It is useful in binary addition and other arithmetic applications. The fast parallel carry output bit allows high-speed operation when used with other adders in a system.

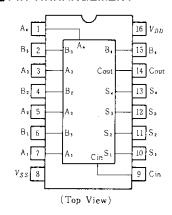
■ FEATURES

- Look-Ahead Carry Output
- · High-Speed Operation; 160ns typ. from Sumin to Sumout
- Quiescent Current; 5nA/pkg typ @5V
- Supply Voltage Range = 3 to 18V
- Pin-for-Pin Replacement for CD4008B and MC14008B

■ LOGIC DIAGRAM



■ PIN ARRANGEMENT



■ TRUTH TABLE(1 Stage)

Cin	В	A	Cout	S
0	0	0	0	0
0	0	1	0	1
0	1	0	0	1
0	1	1	1	0
1	0	0	0	1
1	0	1	1	0
1	1	0	1	0
1	I	1	1	1

■ ELECTRICAL CHARACTERISTICS

Characteristic	Symbol		Test Conditions -40°C 25°C		25°C	85 °C		°C	Unit		
Characteristic	VDD(V)		rest Conditions	min	max	min	typ	max	min	max	Onit
		5.0			0.05	-	0	0.05	-	0.05	v
	Vol	10	$V_{i\pi} = V_{DD}$ or 0	-	0.05	- :	0	0.05		0.05	
Output Voltage	1	15		-	0.05	_	0	0.05	-	0.05	
	Voн	5.0		4.95	-	4.95	5.0	_	4.95	-	
		10	$V_{in} = 0$ or V_{DD}	9.95	_	9.95	10	_	9.95	-	V
		15		14.95		14.95	15	_ '	14.95	_	
16		5.0	$V_{out} = 4.5 \text{ or } 0.5 \text{V}$	-	1.5		2.25	1.5	-	1.5	
	V_{IL}	10	$V_{out} = 9.0 \text{ or } 1.0\text{V}$	_	3.0	-	4.50	3.0		- 3.0 V - 4.0 3.5 - V 7.0 - V 1.0 - O.6 - O.112 - MA	
Input Voltage		15	$V_{out} = 13.5 \text{ or } 1.5 \text{V}$	-	4.0	_	6.75	4.0	_	4.0	1
		5.0	$V_{out} = 0.5 \text{ or } 4.5 \text{V}$	3.5	_	3.5	2.75	_	3.5	_	v
	V_{IH}	10	$V_{out} = 1.0 \text{ or } 9.0 \text{V}$	7.0	_	7.0	5.50		7.0	-	
		15	$V_{out} = 1.5 \text{ or } 13.5 \text{V}$	11.0	_	11.0	8.25	_	11.0	-	
		5.0	$V_{OH} = 2.5 \text{ V}$ -1.0 $- -0.8 $		-1.7	-	-0.6		_		
:	Іон	5.0	$V_{OH} = 4.6 \mathrm{V}$	-0.2		-0.16	-0.36	_	-0.12	_	mA
		10	V _{OH} = 9.5 V	-0.5	-	-0.4	-0.9	-	-0.3	-	
Output Drive Current		15	$V_{OH} = 13.5 \text{ V}$	-1.4	_	-1.2	-3.5	_	-1.0	_	
	IoL	5.0	$V_{OL} = 0.4 \text{ V}$	0.52		0.44	0.88	_	0.36	_	mА
		10	$V_{OL} = 0.5 \mathrm{V}$	1.3	-	1.1	2.25	_	0.9	_	
		15	$V_{0L} = 1.5 \text{ V}$		-	3.0	8.8	-	2.4	_]
Input Current	Iin	15		_	±0.3	_	±0.00001	±0.3	_	±1.0	μΑ
Input Capacitance	Cin	_	$V_{in} = 0$	_	_	_	5.0	7.5	_	-	pF
	Current	20	_	0.005	20	-	150				
Quiescent Current		-	-	40		0.010	40		300	μΑ	
		15	per Package	_	80	† _	0.015	80	_	600	<u> </u>
ALL BOARD		5.0	Dynamic $+I_{DD}$, $C_L = 50 \text{pF}$	_	_	-	1.7	_		_	→
Total Supply Current*	IT	10	f=1 kHz,	_	_	_	3.4	_		***	
	İ	15	Per Gate	_	_		5.0		-		
T. State and supply appeared of fragmany other than 1914.											

^{*} To calculate total supply current at frequency other than 1kHz. $@V_{DD} = 5.0 \text{ V}$ $I_T = (1.7\mu\text{A/kHz})f + I_{DD}$ $@V_{DD} = 10 \text{ V}$ $I_T = (3.4\mu\text{A/kHz})f + I_{DD}$ $@V_{DD} = 10 \text{ V}$ $I_T = (5.0\mu\text{A/kHz})f + I_{DD}$

■DC CHARACTERISTIC TEST CIRCUIT

$\bullet I_{OH}$ $\bullet I_{OL}$

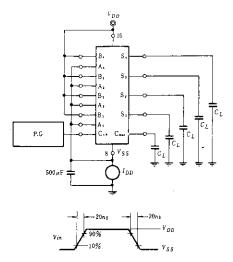
H \bullet I_{OL} v_{OD} = - v_{GS} v_{Ost}

S.

S,

Vowl Vowl Vowl Vowl Vowl IoH B. S. A. B. S. A. Cin Cout External Power Supply 8 VSS

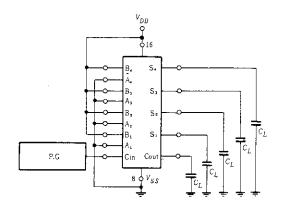
● POWER DISSIPATION TEST CIRCUIT AND WAVEFORM

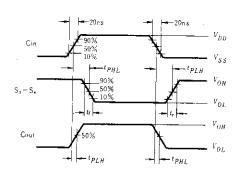


ESWITCHING CHARACTERISTICS $(C_L = 50 \text{pF}, Ta = 25^{\circ}\text{C})$

Character	istic	Symbol	$V_{DD}(V)$	min	typ	max	Unit
Output Rise Time		t _T	5.0		180	360	ns
			10		90	180	
			15	_	65	130	
Output Fall Time		tf	5.0		100	200	ns
			10	_	50	100	
			15		40	80	
	Sum In-to-	tplH, tpHL	5.0		400	800	ns
			10		160	320	
			15		115	230	
	Sum In-to- Carry Out		5.0	_	305	610	
Propagation Delay Time			10	. –	145	290	
			15		110	220	
	Carry In- to- Sum Out		5.0	_	375	750	
			10		155	310	
			15		115	230	
	Carry In-		5.0		170	340	
			10		75	150	
	Carry Out		15	_ 1	55	110	

SWITCHING TIME TEST CIRCUIT





Unit: mm 19.20 20.00 Max 16 7.40 Max 6.30 1.3 1.11 Max 7.62 5.06 Max 2.54 Min 0.51 Min $0.25^{+0.13}_{-0.05}$ 0.48 ± 0.10 2.54 ± 0.25 $0^{\circ} - 15^{\circ}$ Hitachi Code DP-16 **JEDEC** Conforms EIAJ Conforms Weight (reference value) 1.07 g

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